To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

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RENESAS

SILICON POWER TRANSISTOR

Phase-out/Discontinued

2SD1286-Z

NPN SILICON EPITAXIAL TRANSISTOR

DESCRIPTION

The 2SD1286-Z is designed for Switching, especially in Hybrid Integrated Circuits.

FEATURES

- High h_{FE} = 2000 to 30000
- Complement to 2SB963-Z

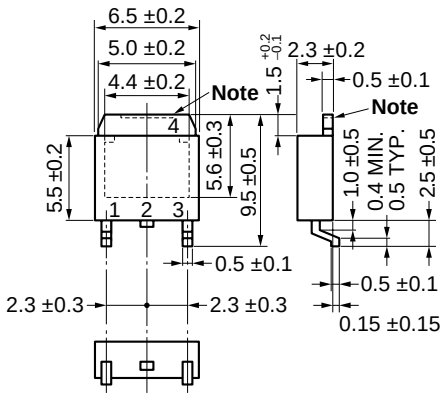
ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Collector to Base Voltage	V_{CBO}	60	V
Collector to Emitter Voltage	V_{CEO}	60	V
Base to Emitter Voltage	V_{EBO}	8	V
Collector Current (DC)	$I_{C(DC)}$	1	A
Collector Current (pulse) Note 1	$I_{C(pulse)}$	2	A
Total Power Dissipation (T_A = 25°C) Note 2	P_T	2.0	W
Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	–55 to +150	°C

Notes 1. PW ≤ 10 ms, Duty Cycle ≤ 50%

2. When mounted on ceramic substrate of 7.5 cm^2 × 0.7 mm

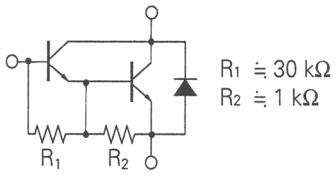
<R> **PACKAGE DRAWING (Unit: mm)**



TO-252 (MP-3Z)

1. Base
2. Collector
3. Emitter
4. Collector Fin

Note The depth of notch at the top of the fin is from 0 to 0.2 mm.



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Date Published July 2006 NS CP(K)
Printed in Japan

The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

ELECTRICAL CHARACTERISTICS (T_a = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	I_{CBO}			10	μA	V_{CB} = 60 V, I_E = 0
Emitter Cutoff Current	I_{EBO}			1.0	mA	V_{EB} = 5.0 V, I_C = 0
DC Current Gain	h_{FE1}*	1 000				V_{CE} = 2.0 V, I_C = 0.2 A
DC Current Gain	h_{FE2}*	2 000		30 000		V_{CE} = 2.0 V, I_C = 0.5 A
Collector Saturation Voltage	$V_{CE(sat)}$*			1.5	V	I_C = 500 mA, I_B = 0.5 mA
Base Saturation Voltage	$V_{BE(sat)}$*			2.0	V	I_C = 500 mA, I_B = 0.5 mA
Turn-on Time	t_{on}		0.5		μs	I_C = 0.5 A, R_L = 100 Ω I_{B1} = −I_{B2} = 0.1 mA V_{CC} = 50 V
Storage Time	t_{stg}		1.0		μs	
Fall Time	t_f		1.0		μs	

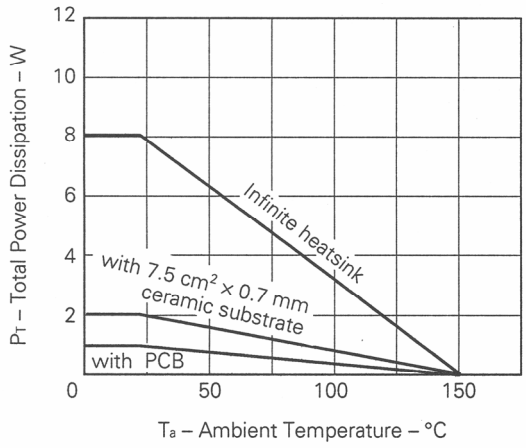
* Pulsed: PW ≦ 350 μs, Duty Cycle ≦ 2 %

h_{FE} Classification

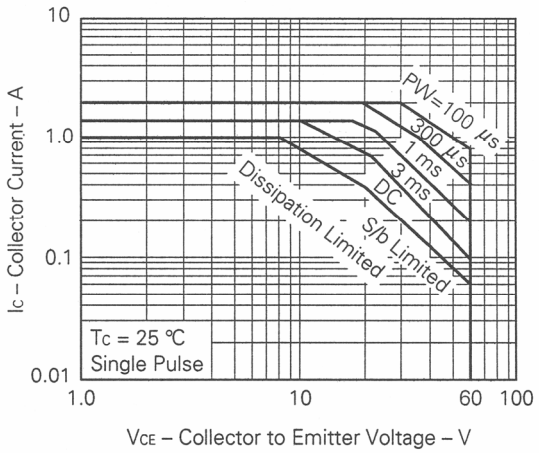
MARKING	M	L	K
h_{FE2}	2 000 to 5 000	4 000 to 10 000	8 000 to 30 000

TYPICAL CHARACTERISTICS (T_a = 25 °C)

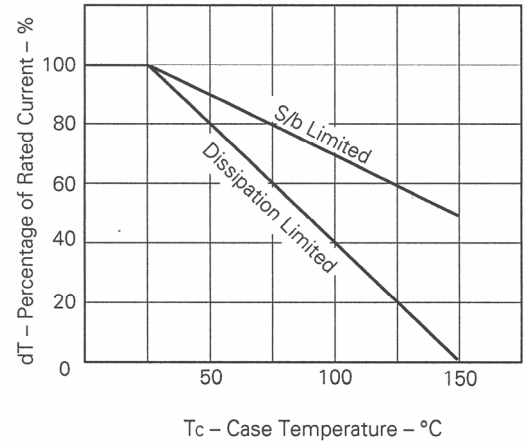
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



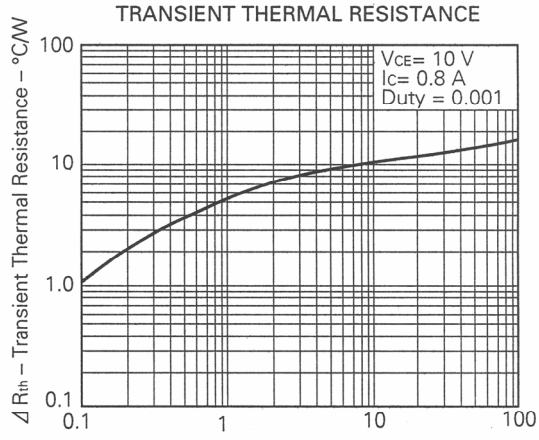
SAFE OPERATING AREA



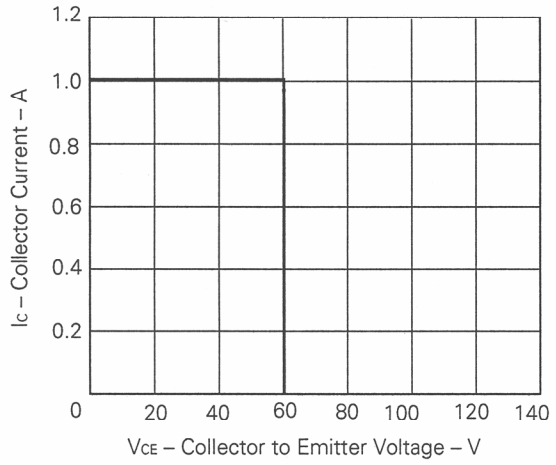
DERATING CURVE OF SAFE OPERATING AREA



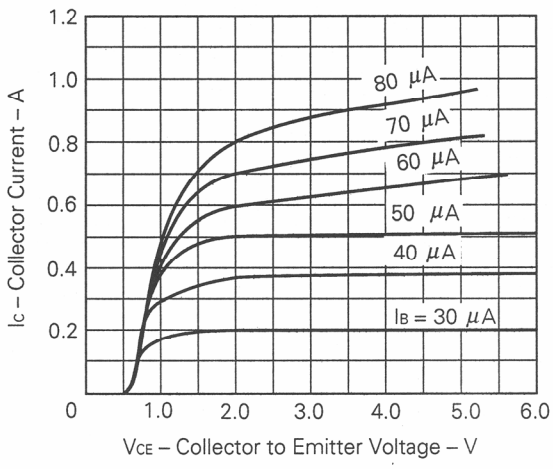
TRANSIENT THERMAL RESISTANCE



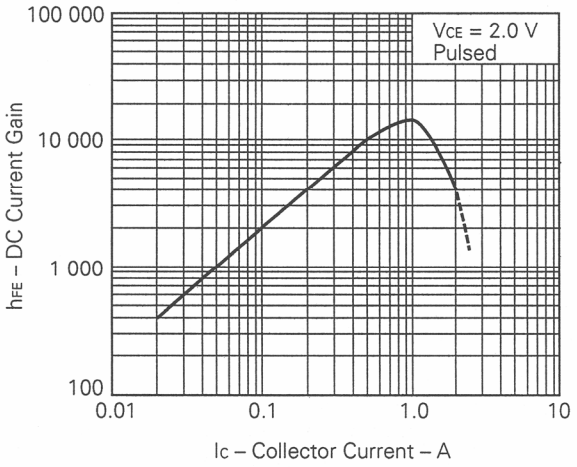
REVERSE BIAS SAFE OPERATING AREA



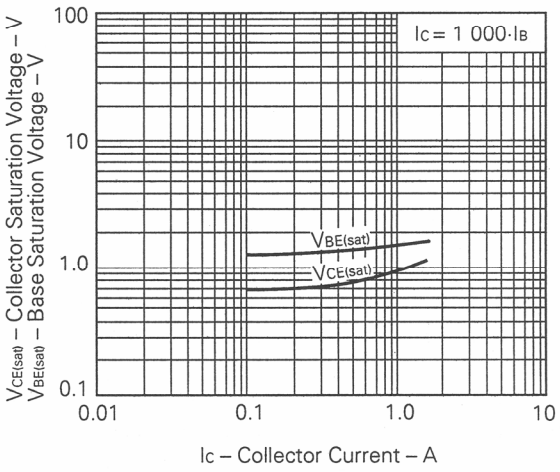
COLLECTOR CURRENT vs.
COLLECTOR TO EMITTER VOLTAGE



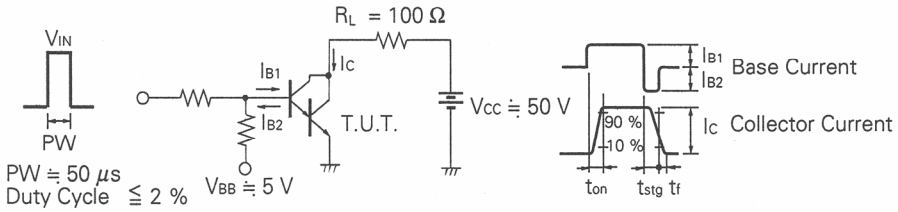
DC CURRENT GAIN vs.
COLLECTOR CURRENT



BASE AND COLLECTOR SATURATION
VOLTAGE vs. COLLECTOR CURRENT



SWITCHING TIME (t_{on}, t_{stg}, t_f) TEST CIRCUIT



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